



Material Content Data Sheet



Halogen-Free

Sales Product Name	IPP040N06N	Issued	11. May 2021
MA#	MA001649838		
Package	PG-TO220-3-1	Weight*	2035.31 mg

Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	1.427	0.07	0.07	701	701
leadframe	inorganic material	phosphorus	7723-14-0	0.245	0.01		120	
	non noble metal	iron	7439-89-6	0.816	0.04		401	
	non noble metal	copper	7440-50-8	815.335	40.08	40.13	400594	401115
wire	non noble metal	aluminium	7429-90-5	7.916	0.39	0.39	3890	3890
encapsulation	inorganic material	zinc oxide	1314-13-2	5.961	0.29		2929	
	miscellaneous	miscellaneous	-	23.845	1.17		11716	
	plastics	epoxy resin	-	89.418	4.39		43933	
	inorganic material	silicon dioxide	60676-86-0	476.894	23.43	29.28	234310	292888
lead finish	non noble metal	tin	7440-31-5	21.462	1.05	1.05	10545	10545
plating	inorganic material	phosphorus	7723-14-0	0.001			1	
	non noble metal	nickel	7440-02-0	0.244	0.01	0.01	120	121
solder	non noble metal	tin	7440-31-5	0.030			15	
	noble metal	silver	7440-22-4	0.038			19	
	non noble metal	lead	7439-92-1	1.443	0.07	0.07	709	743
heatspreader	inorganic material	phosphorus	7723-14-0	0.177	0.01		87	
	non noble metal	iron	7439-89-6	0.590	0.03		290	
	non noble metal	copper	7440-50-8	589.466	28.96	29.00	289620	289997
*deviation	< 10%	Sum in total:				100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and contains Pb according RoHS exemption 7a, Lead in high melting temperature type solders.

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